NSN 5962-01-117-8544

Memory Microcircuit - Page 1 of 1

Fiig: A458a0



View Online at https://aerobasegroup.com/nsn/5962-01-117-8544 **Body Length:** Between 0.755 inches and 0.785 inches **Body Width:** Between 0.220 inches and 0.280 inches **Body Height:** Between 0.140 inches and 0.180 inches **Maximum Power Dissipation Rating:** 450.0 milliwatts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **End Application:** Receiving set, countermeasures, type an/alr-20a **Features Provided:** Hermetically sealed and monolithic and positive outputs **Inclosure Material:** Ceramic and glass **Inclosure Configuration:** Dual-in-line **Input Circuit Pattern:** 6 input **Case Outline Source And Designator:** T0-116 joint electron device engineering council **Time Rating Per Chacteristic:** 50.00 nanoseconds propagation delay time, low to high level output **Memory Device Type:** Rom **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). Shelf Life: N/a **Unit Of Measure: Demilitarization:** Yes - demil/mli